

# **SMAG Plastic-Encapsulate Diodes**

## **General Purpose Rectifier**

#### **Features**

•l<sub>0</sub> 1A

●VRRM 2000V

High surge current capability

•Glass passivated chip

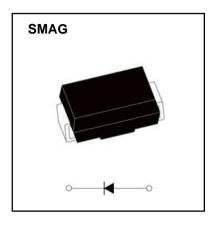
• Polarity: Color band denotes cathode

## **Applications**

Rectifier

## Marking

• HD20G



# **Limiting Values (Absolute Maximum Rating)**

| Item                                    | Symbol             | Unit       | Conditions                                      | HD20G              |
|---|--------------------|------------|---|--------------------|
| Repetitive Peak Reverse Voltage         | VRRM               | V          |   | 2000               |
| Maximum RMS Voltage                     | VRMS               | V          |   | 1400               |
| Average Forward Current                 | I <sub>F(AV)</sub> | Α          | 60HZ Half-sine wave,<br>Resistance load,Ta=75°C | 1                  |
| Surge(Non-repetitive)Forward<br>Current | I <sub>FSM</sub>   | Α          | 60HZ Half-sine wave,1<br>cycle,Ta=25℃           | 30                 |
| Junction Temperature                    | Tj                 | $^{\circ}$ |   | -55~+150           |
| Storage Temperature                     | T <sub>stg</sub>   | $^{\circ}$ |   | -55 ~ <b>+</b> 150 |

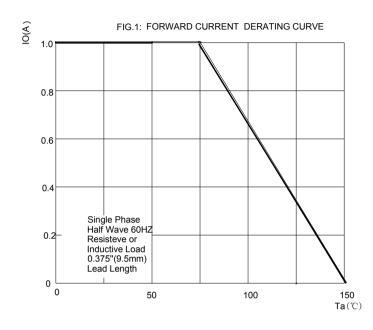
## Electrical Characteristics (Ta=25°C Unless otherwise specified)

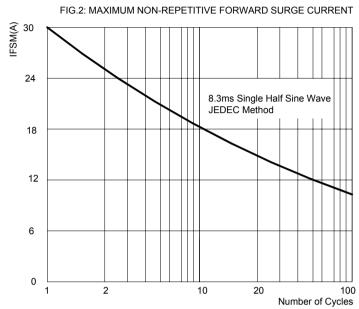
| Item                           | Symbol            | Unit | Test Co                           | ndition               | Мах |
|--------------------------------|-------------------|------|-----------------------------------|-----------------------|-----|
| Peak Forward Voltage           | $V_{FM}$          | ٧    | I <sub>FM</sub> =1.0A             |                       | 2.0 |
| Peak Reverse Current           | IRRM1             | μΑ   | V <sub>RM</sub> =V <sub>RRM</sub> | T <sub>a</sub> =25℃   | 5   |
|                                | I RRM2            |      |                                   | T <sub>a</sub> =125°C | 50  |
| Thermal<br>Resistance(Typical) | $R_{\theta J-A}$  | °C/W | Between junction and ambient      |                       | 55  |
|                                | R <sub>θJ-L</sub> |      | Between junction and lead         |                       | 25  |

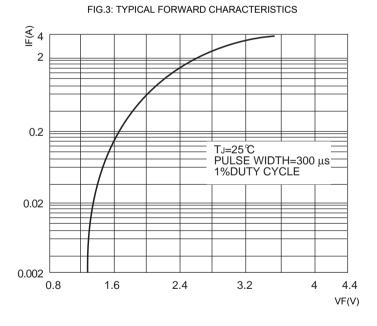
#### Notes:

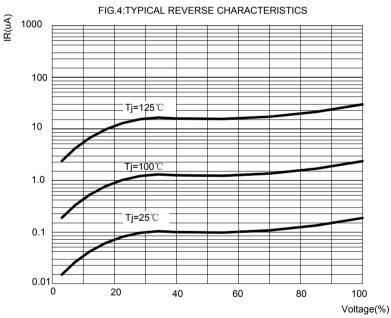
Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

# **Typical Characteristics**

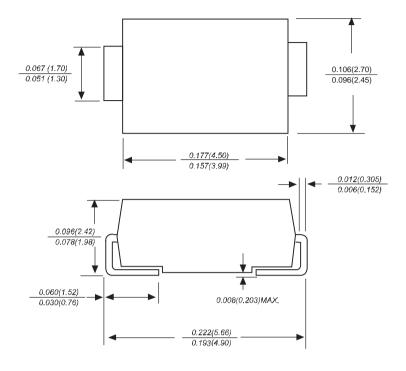






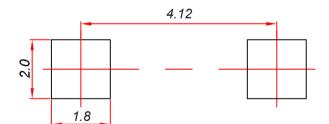


## **SMAG** Package Outline Dimensions



Dimensions in inches and (millimeters)

# **SMAG Suggested Pad Layout**



#### Note:

- 1. Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.
- 3. The pad layout is for reference purposes only.

#### NOTICE

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# **Reel Taping Specifications For Surface Mount Devices-SMAG**

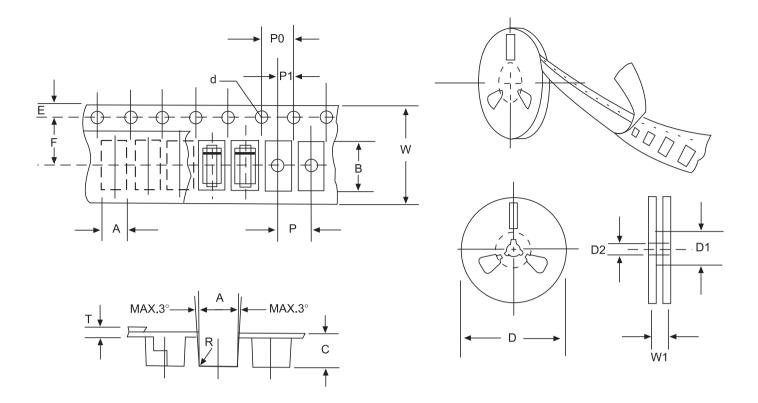


Fig:CONFIGURATION OF FLAT MELF TAPING

| ITEM                   | SYMBOL | SMAG mm(inch)           |
|------------------------|--------|-------------------------|
| Carrier width          | А      | 2.79±0.1(0.110±0.004)   |
| Carrier length         | В      | 5.33±0.1(0.210±0.004)   |
| Carrier depth          | С      | 2.36±0.1(0.093±0.004)   |
| Sprocket hole          | d      | 1.55±0.05 (0.061±0.002) |
| Reel outside diameter  | D      | 279±2.0 (11±0.079)      |
| Reel inner diameter    | D1     | 75±1.0 (2.95±0.039)     |
| Feed hole diameter     | D2     | 13±0.5(0.512±0.020)     |
| Strocket hole position | E      | 1.75±0.1(0.069±0.004)   |
| Punch hole position    | F      | 5.5±0.05(0.217±0.002)   |
| Punch hole pitch       | Р      | 4.0±0.1(0.157±0.004)    |
| Sprocket hole pitch    | P0     | 4.0±0.1(0.157±0.004)    |
| Embossment center      | P1     | 2.0±0.1(0.079±0.004)    |
| Totall tape thickness  | Т      | 0.28±0.02(0.011±0.0008) |
| Tape width             | W      | 12.0±0.2(0.472±0.008)   |
| Reel width             | W1     | 16.8±2.0(0.661±0.079)   |

NOTE:Devices are packde in accordance with EIA standard RS-481-A and specification given above.

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